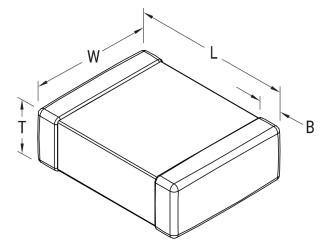


C2225Q474K5XAC GR900 SMD Space, Ceramic, 0.47 uF, 10%, 50 VDC, BX, N/A, 2225



Click here for the 3D model.

| Dimensions | | |
|------------|--|--|
| Chip Size | 2225 | |
| L | 5.59mm +/-0.38mm (0.22 in +/-0.015 in) | |
| W | 6.35mm +/-0.38mm (0.25 in +/-0.015 in) | |
| Т | 2.03mm MAX (0.08 in MAX) | |
| В | 0.51mm +/-0.25mm (0.02 in +/-0.01 in) | |

Packaging Specifications

Packaging

Bulk, Bag

| General Information | | | |
|-------------------------|---------------------|--|--|
| Series | GR900 SMD Space | | |
| Style | SMD Chip | | |
| RoHS | Yes | | |
| Termination | Tin | | |
| Failure Rate | N/A | | |
| Testing and Reliability | Mil-PRF-123 Group A | | |
| Qualifications | MIL-PRF-123 Group A | | |
| AEC-Q200 | No | | |
| Shelf Life | 78 Weeks | | |
| MSL | 1 | | |

| Specifications | | | |
|-------------------------|------------|--|--|
| Capacitance | 0.47 uF | | |
| Capacitance Tolerance | 10% | | |
| Voltage DC | 50 VDC | | |
| Temperature Range | -55/+125°C | | |
| Temperature Coefficient | BX | | |

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

单击下面可查看定价,库存,交付和生命周期等信息

>>KEMET(基美)